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SOI CMOS MEMS Infra-Red Thermal Source with Carbon Nanotubes Coating


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Abstract

This abstract presents the development of a Silicon-on-Insulator (SOI) CMOS micro-electro-mechanical (MEMS) micro-hotplate based infra-red (IR) light source employing a vertically aligned multi-walled carbon nanotubes (VA-MWCNTs) emission layer. Chips were batch fabricated using a standard SOI CMOS process with tungsten metalization followed by a deep reactive ion etching (DRIE) post-CMOS process. VA-MWCNTs were grown at the chip level with a proven in-situ technique. The CNTs coated devices were compared with uncoated devices. Herein we discuss the device performance in terms of power dissipation, beam collimation, thermal transient times, integrated emitted radiation and emitted radiation spectral profile.

Keywords: Thermal source; Micro-hotplate; Carbon-nanotubes; Silicon-on-insulator; CMOS, MEMS.
1. Introduction

Recently, the demand for miniaturized, low-cost, highly-selective and long lifetime carbon dioxide gas sensors has significantly increased due to the increase in affordable mobile consumer electronics. Non-dispersive-infra-red (NDIR) spectroscopy [1] is believed to be a promising sensing technique, due to its intrinsically high-selectivity and mechanical robustness. Nevertheless, issues related to size and cost of traditional systems must be resolved before wide-scale adoption. CMOS technologies are certainly one very attractive route for the fabrication of the main components of an NDIR sensor (IR source and IR detector), since they permit aggressive size reductions and low-cost/high-volume production. Unfortunately, CMOS compatible materials often have poor emissive and absorptive properties [2]. In [3], we demonstrated CO$_2$ detection can be significantly improved by the inclusion of a CNTs ad-layer and that the emitter is surprisingly stable up to a working temperature of 500°C. Herein we present a new IR source design with improved performance and we carry out an extensive analysis of its characteristics.

2. IR thermal source design and fabrication

The IR thermal source (chip size 2.4 mm × 2.4 mm) was designed using the CADENCE Virtuoso design platform and fabricated in SOI CMOS technology, in a commercial foundry. In Fig. 1a, an optical micrograph of the developed IR thermal source is shown. A schematic cross section of the SOI CMOS MEMS technology is depicted in Fig. 1b. High temperature tungsten metallization was used as the resistive material for the micro-heater and the interconnects. Tungsten was chosen due to its very high melting point (> 3400 °C) and lower susceptibility to electromigration when compared to aluminum or polysilicon. The micro-heater has a circular multi-ring structure with a diameter of 1.4 mm, embedded within an ~ 5 μm thick, 2mm diameter dielectric membrane released by a post-CMOS DRIE process. During this fabrication step, the buried oxide layer acts as an effective etch-stop. The DRIE process allows for the realization of nearly vertical side-walls, thereby permitting aggressive miniaturization. The circular design of the membrane allows for uniform intrinsic stress distribution at the membrane’s edge. The membrane thermally isolates the micro-heater from the substrate, allowing temperatures in excess of 600 °C to be reached in the heater area. Si$_3$N$_4$ is used as passivation layer. Several devices were wedge-bonded onto TO5 packages, to allow in situ (only on the heater area) VA-MWCNTs growth [4]. First, a bilayer catalyst Al/Fe (10/1 nm) was DC magnetron sputtered and the micro-hotplate was employed as the micro-reactor, allowing VA-MWCNTs to grow (at 700 °C for 10 min ) by thermal chemical vapor deposition (T-CVD) in a 4% H$_2$:C$_2$H$_2$ atmosphere at 25 mbar. MWCNTs growth was subsequently verified by optical microscopy and scanning electron microscopy.

3. Results and discussion

NDIR spectroscopy is based on the principle that the vibrational and rotational frequencies are particular to given molecules providing a specific and characteristic signature. These phases are responsible for the absorption of specific wavelengths in the IR window. A NDIR sensor relies on (i) a light source to generate IR radiation, which is partially absorbed by the target gas, as postulated by the Beer-Lambert law; (ii) an optical filter, which spectrally selects the wavelengths of interest; and (iii) an IR detector, which detects the radiation transmitted through the filter. The detector output can then be correlated to the gas concentration via a calibration procedure. A thermal source is an electro-thermo-optical transducer. The electro-thermal transduction is performed via Joule heating in a resistive component (i.e. the micro-hotplate). The thermal energy is then partially dissipated through the membrane by conduction, and partially through the ambient via convection. Typical power vs. temperature curves for the proposed thermal source are presented in Fig. 2a, for both coated and uncoated devices. VA-MWCNTs grown only on the heater area do not offer a thermal bridge between the “hot zone” and the substrate, thus no extra conduction losses are present. The remainder energy accounts for the functional and measurable optical component via radiation. In Fig. 2b the response of a commercial thermopile (Heimann HMS J21 with a 3μm - 6μm optical filter) is shown to
be increased by 130% (for a power dissipation of 210 mW), if a device with the proposed emissive layer is employed. This finding is supported by Fig. 3a, which shows the spectra of coated and uncoated IR sources measured with a Perkin Elmer Frontier FTIR system. The emission intensity is clearly enhanced for wavelengths < 8 μm. This region of the spectrum is particularly interesting for sensing also other gases in addition to CO₂, as illustrated in Fig. 3b. The electrical modulation capabilities of the functionalized emitters were also studied, since
pulsed emission is an effective route towards power and noise reduction. A 30% degradation of the total thermal transient time ($\tau_{10\%-90\%} + \tau_{90\%-10\%}$) of the coated devices was measured with a fast response IR detector (IG26 PIN photodiode by Laser Components) (Fig. 5), we believe due to the extra mass of the VA-MWCNTs. Finally, the IR source angular beam profile is shown in Fig. 4b. Accurate knowledge of the degree of collimation is of prime importance for the design of micro-IR optical systems to maximize the detector response at a minimised emitter power. The presence of the VA-MWCNTs emission layer has a minimal effect on the beam dispersion with only a slight increase in collimation.

4. Conclusions

We have presented the development of a SOI CMOS MEMS micro-hotplate based IR light source employing a vertically aligned multi-walled carbon nanotubes coating for thermal emission enhancement. Chips were batch fabricated with a standard SOI CMOS process. Tungsten was used as metal for the micro-hotplate and interconnects. A DRIE post-CMOS process step was used to release the membrane. VA-MWCNTs were grown in-house at chip level with a proven in-situ T-CVD technique. The CNTs coated devices were evaluated against nascent, uncoated devices. The VA-MWCNTs coating is shown to: (i) not degrade the heater power dissipation, (ii) slightly improve the beam collimation, (iii) increase the total transient time ($\tau_{10\%-90\%} + \tau_{90\%-10\%}$) by 30%, (iv) enhance the emitted radiation by 130% at a working temperature of 400°C in the 3μm - 6μm range.

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References